

NI R Series Multifunction RIO Specifications

This document lists the specifications of the NI 781xR/783xR/784xR/785xR. These specifications are typical at 25 °C unless otherwise noted.

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Analog Input (NI 783xR/784xR/785xR Only)

Input Characteristics

Number of channels

NI 7830R 4
NI 7831R/7833R/7841R/7842R/
7851R/7852R/7853R/7854R 8

Input modes DIFF, RSE, NRSE
(software-selectable;
selection applies to all
channels)

Type of ADC Successive
approximation

Resolution 16 bits, 1 in 65,536

Conversion time

NI 783xR/NI 784xR 4 µs
NI 785xR 1 µs

Maximum sampling rate

NI 783xR/784xR 200 kS/s (per channel)
NI 785xR 750 kS/s (per channel)

Input impedance

Powered on 10 GΩ in parallel with
100 pF
Powered off/overload 4.0 kΩ min

Input signal range ±10 V

Input bias current

NI 783xR ±2 nA
NI 784xR/785xR ±5 nA

Input offset current

NI 783xR ±1 nA
NI 784xR/785xR ±5 nA

Input coupling DC

Maximum working voltage
(signal + common mode) Inputs should remain
within ±12 V of ground

Overshoot protection

Powered on ±42 V
Powered off ±35 V

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Accuracy Information

NI 783xR

Nominal Range (V)		Absolute Accuracy						Relative Accuracy		
		% of Reading		Offset (μ V)	Noise + Quantization (μ V)		Temp Drift (%/ $^{\circ}$ C)	Absolute Accuracy at Full Scale (\pm mV)	Resolution (μ V)	
Positive Full Scale	Negative Full Scale	24 Hours	1 Year		Single Point	Averaged			Single Point	Averaged
10.0	-10.0	0.0496	0.0507	2,542	1,779	165	0.0005	7.78	2,170	217

Note: Accuracies are valid for measurements following an internal calibration. Averaged numbers assume dithering and averaging of 100 single-channel readings. Measurement accuracies are listed for operational temperatures within ± 1 $^{\circ}$ C of internal calibration temperature and ± 10 $^{\circ}$ C of external or factory-calibration temperature.

NI 784xR/785xR

Nominal Range (V)		Absolute Accuracy						Relative Accuracy		
		% of Reading		Offset (μ V)	Noise + Quantization (μ V)		Temp Drift (%/ $^{\circ}$ C)	Absolute Accuracy at Full Scale (\pm mV)	Resolution (μ V)	
Positive Full Scale	Negative Full Scale	24 Hours	1 Year		Single Point	Averaged			Single Point	Averaged
10.0	-10.0	0.0186	0.0228	1,591	1,029	91.6	0.0005	3.97	1,205	121

Note: Accuracies are valid for measurements following an internal calibration. Averaged numbers assume dithering and averaging of 100 single-channel readings. Measurement accuracies are listed for operational temperatures within ± 1 $^{\circ}$ C of internal calibration temperature and ± 10 $^{\circ}$ C of external or factory-calibration temperature.

DC Transfer Characteristics

INL

- NI 783xR ± 3 LSB typ, ± 6 LSB max
- NI 784xR/785xR ± 1 LSB typ, ± 3 LSB max

DNL

- NI 783xR -1.0 to +2.0 LSB max
- NI 784xR/785xR ± 0.4 LSB typ,
 ± 0.9 LSB max

No missing codes

- NI 783xR 16 bits typ, 15 bits min
- NI 784xR/785xR 16 bits guaranteed

CMRR, DC to 60 Hz

Dynamic Characteristics

Bandwidth

NI 783xR

- Small signal (-3 dB) 650 kHz
- Large signal (1% THD) 55 kHz

NI 784xR/785xR

- Small signal (-3 dB) 1 MHz
- Large signal (1% THD) 500 kHz

Settling Time

Device	Step Size	Accuracy		
		± 16 LSB	± 4 LSB	± 2 LSB
NI 783xR	± 20.0 V	7.5 μ s	10.3 μ s	40 μ s
	± 2.0 V	2.7 μ s	4.1 μ s	5.1 μ s
	± 0.2 V	1.7 μ s	2.9 μ s	3.6 μ s
NI 784xR/ 785xR	± 20.0 V	2.1 μ s	4.2 μ s	8 μ s
	± 2.0 V	1.3 μ s	1.6 μ s	1.8 μ s
	± 0.2 V	0.8 μ s	1.1 μ s	1.2 μ s

Crosstalk -80 dB, DC to 100 kHz

Analog Output (NI 783xR/784xR/785xR Only)

Output Characteristics

Output type	Single-ended, voltage output	Resolution.....	16 bits, 1 in 65,536
Number of channels		Update time	1.0 μ s
NI 7830R	4	Maximum update rate.....	1 MS/s
NI 7831R/7833R/7841R/7842R/ 7851R/7852R/7853R/7854R	8	Type of DAC	Enhanced R-2R

Accuracy Information

Nominal Range (V)		Absolute Accuracy				Absolute Accuracy at Full Scale (mV)
		% of Reading		Offset (μ V)	Temp Drift (%/ $^{\circ}$ C)	
Positive Full Scale	Negative Full Scale	24 Hours	1 Year			
10.0	-10.0	0.0335	0.0351	2366	0.0005	5.88

Note: Accuracies are valid for analog output following an internal calibration. Analog output accuracies are listed for operation temperatures within ± 1 $^{\circ}$ C of internal calibration temperature and ± 10 $^{\circ}$ C of external or factory calibration temperature. Temp Drift applies only if ambient is greater than ± 10 $^{\circ}$ C of previous external calibration.

DC Transfer Characteristics

INL	± 0.5 LSB typ, ± 4.0 LSB max
DNL	± 0.5 LSB typ, ± 1 LSB max
Monotonicity	16 bits, guaranteed

Voltage Output

Range	± 10 V
Output coupling	DC
Output impedance	
NI 783xR	1.25 Ω
NI 784xR/785xR	0.5 Ω
Current drive	± 2.5 mA
Protection	Short-circuit to ground
Power-on state	User configurable

Dynamic Characteristics

Settling time	Accuracy		
Step Size			Absolute Accuracy
± 20.0 V	± 16 LSB	± 4 LSB	± 2 LSB
± 2.0 V	6.0 μ s	6.2 μ s	7.2 μ s
± 0.2 V	2.2 μ s	2.9 μ s	3.8 μ s
	1.5 μ s	2.6 μ s	3.6 μ s

Slew rate

Noise

Glitch energy
at midscale transition

10 V/ μ s

150 μ V_{rms}, DC to 1 MHz

± 200 mV for 3 μ s

Digital I/O

Number of channels

NI 781xR.....	160
NI 7830R.....	56
NI 7831R/7833R/7841R/7842R/ 7851R/7852R/7853R/7854R	96
Compatibility.....	TTL

Digital logic levels

Level	Min	Max
Input low voltage (V_{IL})	0.0 V	0.8 V
Input high voltage (V_{IH})	2.0 V	5.5 V
Output low voltage (V_{OL}), where $I_{OUT} = -4$ mA	0 V	0.4 V
Output high voltage (V_{OH}), where $I_{OUT} = 4$ mA	2.4 V	3.3 V

Output current

Source	4.0 mA
Sink	4.0 mA

Input leakage current

Power-on state

Protection

Input	
NI 781xR/783xR.....	-0.5 to 7.0 V, single line
NI 784xR/785xR	-20.0 to 20.0 V, single line
Output	Short-circuit (up to eight lines may be shorted at a time)

Minimum pulse width

Input	25 ns
Output	12.5 ns

Minimum sampling period

Reconfigurable FPGA
NI 7811R/7830R/7831R
FPGA type..... Virtex-II V1000
Number of flip-flops..... 10,240
Number of 4-input LUTs..... 10,240
Number of 18×18 multipliers... 40
Embedded block RAM..... 720 kbits
NI 7813R/7833R
FPGA type..... Virtex-II V3000
Number of flip-flops..... 28,672
Number of 4-input LUTs..... 28,672
Number of 18×18 multipliers... 96
Embedded block RAM..... 1,728 kbits
NI 7841R/7851R
FPGA type..... Virtex-5 LX30
Number of flip-flops..... 19,200
Number of 6-input LUTs..... 19,200
Number of DSP48 slices (25×18 multipliers)..... 32
Embedded block RAM..... 1,152 kbits
NI 7842R/7852R
FPGA type..... Virtex-5 LX50
Number of flip-flops..... 28,800
Number of 6-input LUTs..... 28,800
Number of DSP48 slices (25×18 multipliers)..... 48
Embedded block RAM..... 1,728 kbits
NI 7853R
FPGA type..... Virtex-5 LX85
Number of flip-flops..... 51,840
Number of 6-input LUTs..... 51,840
Number of DSP48 slices (25×18 multipliers)..... 48
Embedded block RAM..... 3,456 kbits
NI 7854R
FPGA type..... Virtex-5 LX110
Number of flip-flops..... 69,120
Number of 6-input LUTs..... 69,120
Number of DSP48 slices (25×18 multipliers)..... 64
Embedded block RAM..... 4,608 kbits
Timebase
40, 80, 120, 160, or 200 MHz

Timebase reference sources	
NI PCI-781xR/783xR	Onboard clock only
NI PCIe-784xR/785xR	Onboard clock only
NI PXI-78xxR	Onboard clock, phase-locked to PXI 10 MHz clock
Timebase accuracy, onboard clock	±100 ppm, 250 ps peak-to-peak jitter
Phase locked to PXI 10 MHz	
Clock (NI PXI-78xxR only)	Adds 350 ps peak-to-peak jitter
Additional frequency-dependent peak-to-peak jitter	
NI 781xR/783xR	
40 MHz	None
80 MHz	400 ps
120 MHz	720 ps
160 MHz	710 ps
200 MHz	700 ps
NI 784xR/785xR	
40 MHz	None
80 MHz	460 ps
120 MHz	172 ps
160 MHz	172 ps
200 MHz	152 ps
Calibration (NI 783xR/784xR/785xR Only)	
Recommended warm-up time	15 minutes
Calibration interval	1 year
Onboard calibration reference	
DC level	5.000 V (± 3.5 mV) (actual value stored in Flash memory)
Temperature coefficient	±5 ppm/°C max
Long-term stability	±20 ppm/ \sqrt{t} , 1,000 h
	Note Refer to <i>Calibration Certificates</i> at ni.com/calibration to generate a calibration certificate for the NI 78xxR.

Bus Interface

PCI/PCIe/PXI	Master, slave
Data transfers	DMA, interrupts, programmed I/O
Number of DMA channels	3

Power Requirement

+5 VDC ($\pm 5\%$) ¹	
NI 781xR	9 mA typ
NI 7830R/7831R	330 mA typ
NI 7833R	364 mA typ
NI PXI-7841R/7851R	125 mA typ
NI PXI-7842R/7852R	136 mA typ
NI 7853R	460 mA typ
NI 7854R	484 mA typ
+3.3 VDC ($\pm 5\%$) ²	
NI 7811R	650 mA typ
NI 7813R	850 mA typ
NI 7830R/7831R	462 mA typ
NI 7833R	727 mA typ
NI PCIe-7841R/7851R	847 mA typ
NI PCIe-7842R/7852R	984 mA typ
NI PXI-7841R/7851R	525 mA typ
NI PXI-7842R/7852R	604 mA typ
NI 7853R	640 mA typ
NI 7854R	843 mA typ
+12 V	
NI 784xR/785xR	0.5 A
-12 V	
NI PXI-784xR/785xR	0.25 A
+5V terminal	
Connector 0	0.5 A max ³
Connector 1	0.5 A max ³
Connector 2	0.5 A max ³
All connectors	1.5 A max ^{3,4}

¹ Does not include current drawn from the +5 V line on the I/O connectors.

² Does not include current sourced by the digital outputs.

³ (NI PCIe-78xxR only) Total maximum terminal current for all connectors is 100 mA unless disk drive connector is attached.

⁴ (NI 784xR/785xR only) The NI 784xR/785xR has a user-replaceable socketed fuse that opens when current exceeds the current specification. Refer to the *NI R Series Multifunction RIO User Manual*, available at ni.com/manuals, for information about fuse replacement.

To calculate the total current sourced by the digital outputs, use the following equation:

$$\sum_{i=1}^j \text{current sourced on channel } i$$

Power available at I/O connectors ... 4.50 to 5.25 VDC at 1 A total, 250 mA per I/O connector pin

Physical

Dimensions (not including connectors)

NI PCI-781xR/783xR.....	17 cm by 11 cm (6.7 in. by 4.3 in.)
NI PCIe-784xR/785xR.....	17 cm by 11 cm (6.7 in. by 4.3 in.)
NI PXI-78xxR	16 cm by 10 cm (6.3 in. by 3.9 in.)

Weight

NI PCI-781xR/783xR.....	112 g
NI PCIe-784xR/785xR.....	127 g
NI PXI-78xxR	152 g

I/O connectors

NI 781xR.....	Four 68-pin female high-density VHDCI type
NI 7830R.....	Two 68-pin female high-density VHDCI type
NI 783xR/784xR/785xR.....	Three 68-pin female high-density VHDCI type

Disk drive power connector

(PCIe devices) Standard ATX peripheral connector (not serial ATA)

Maximum Working Voltage (NI 783xR/784xR/785xR Only)

Maximum working voltage refers to the signal voltage plus the common-mode voltage.

Channel-to-earth ±12 V, Measurement Category I

Channel-to-channel ±24 V, Measurement Category I



Caution Do not use the NI 783xR/784xR/785xR for connection to signals in Measurement Categories II, III, or IV.

Environmental

The NI 78xxR is intended for indoor use only.

Operating Environment

NI 781xR..... 0 °C to 55 °C,
tested in accordance with
IEC-60068-2-1 and
IEC-60068-2-2.

NI 7830R, NI 7831R

40 MHz or 80 MHz timebase 0 °C to 55 °C,
tested in accordance with
IEC-60068-2-1 and
IEC-60068-2-2.

NI PCI/PXI-7833R

40 MHz timebase 0 °C to 55 °C,
tested in accordance with
IEC-60068-2-1 and
IEC-60068-2-2.

80 MHz timebase 0 °C to 55 °C except the
following: 0 °C to 45 °C
when installed in an
NI PXI-1000/B or
NI PXI-101X,
tested in accordance with
IEC-60068-2-1 and
IEC-60068-2-2.

NI PXI-7841R/7842R/7851R/7852R/7853R/7854R

40 MHz timebase 0 °C to 55 °C,
tested in accordance with
IEC-60068-2-1 and
IEC-60068-2-2.

80 MHz timebase 0 °C to 55 °C except the
following: 0 °C to 45 °C
when installed in an
NI PXI-1000/B or
NI PXI-101X,
tested in accordance with
IEC-60068-2-1 and
IEC-60068-2-2.

NI PCIe-7841R/7842R/7851R/7852R

40 MHz or 80 MHz timebase 0 °C to 40 °C,
tested in accordance with
IEC-60068-2-1 and
IEC-60068-2-2.

Relative humidity range 10% to 90%,
noncondensing,
tested in accordance with
IEC-60068-2-56.

Altitude 2,000 m at 25 °C ambient
temperature

Storage Environment

NI PCI/PXI-781xR/783xR	–20 °C to 70 °C, tested in accordance with IEC-60068-2-1 and IEC-60068-2-2.
NI PCIe-784xR/785xR	–20 °C to 70 °C, tested in accordance with IEC-60068-2-1 and IEC-60068-2-2.
NI PXI-784xR/785xR	–40 °C to 70 °C, tested in accordance with IEC-60068-2-1 and IEC-60068-2-2.
Ambient temperature range	–20 °C to 70 °C, tested in accordance with IEC-60068-2-1 and IEC-60068-2-2.
Relative humidity range.....	5% to 95%, noncondensing, tested in accordance with IEC-60068-2-56.



Note Clean the device with a soft, non-metallic brush. Make sure that the device is completely dry and free from contaminants before returning it to service.

Shock and Vibration (for NI PXI-78xxR Only)

Operational shock	30 g peak, half-sine, 11 ms pulse; tested in accordance with IEC-60068-2-27. Test profile developed in accordance with MIL-PRF-28800F.
Random vibration	
Operating	5 Hz to 500 Hz, 0.3 g _{rms}
Nonoperating	5 Hz to 500 Hz, 2.4 g _{rms} , tested in accordance with IEC-60068-2-64. Nonoperating test profile exceeds the requirements of MIL-PRF-28800F, Class 3.

Safety

The NI 78xxR is designed to meet the requirements of the following standards of safety for electrical equipment for measurement, control, and laboratory use:

- IEC 61010-1, EN 61010-1
- UL 61010-1, CSA 61010-1



Note For UL and other safety certifications, refer to the product label or the [Online Product Certification](#) section.

Electromagnetic Compatibility

The NI 78xxR is designed to meet the requirements of the following standards of EMC for electrical equipment for measurement, control, and laboratory use:

- EN 61326 (IEC 61326): Class A emissions;
Basic immunity
- EN 55011 (CISPR 11): Group 1, Class A emissions
- AS/NZS CISPR 11: Group 1, Class A emissions
- FCC 47 CFR Part 15B: Class A emissions
- ICES-001: Class A emissions



Note For the standards applied to assess the EMC of this product, refer to the [Online Product Certification](#) section.



Note For EMC compliance, operate this device with shielded cabling.

CE Compliance

This product meets the essential requirements of applicable European Directives as follows:

- 2006/95/EC; Low-Voltage Directive (safety)
- 2004/108/EC; Electromagnetic Compatibility Directive (EMC)

Online Product Certification

Refer to the product Declaration of Conformity (DoC) for additional regulatory compliance information. To obtain product certifications and the DoC for this product, visit ni.com/certification, search by model number or product line, and click the appropriate link in the Certification column.

Environmental Management

NI is committed to designing and manufacturing products in an environmentally responsible manner. NI recognizes that eliminating certain hazardous substances from our products is beneficial to the environment and to NI customers.

For additional environmental information, refer to the *NI and the Environment* Web page at ni.com/environment. This page contains the environmental regulations and directives with which NI complies, as well as other environmental information not included in this document.

Waste Electrical and Electronic Equipment (WEEE)



EU Customers At the end of their life cycle, all products *must* be sent to a WEEE recycling center. For more information about WEEE recycling centers and National Instruments WEEE initiatives, visit ni.com/environment/weee.htm.

电子信息产品污染控制管理办法（中国 RoHS）



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Device Pinouts

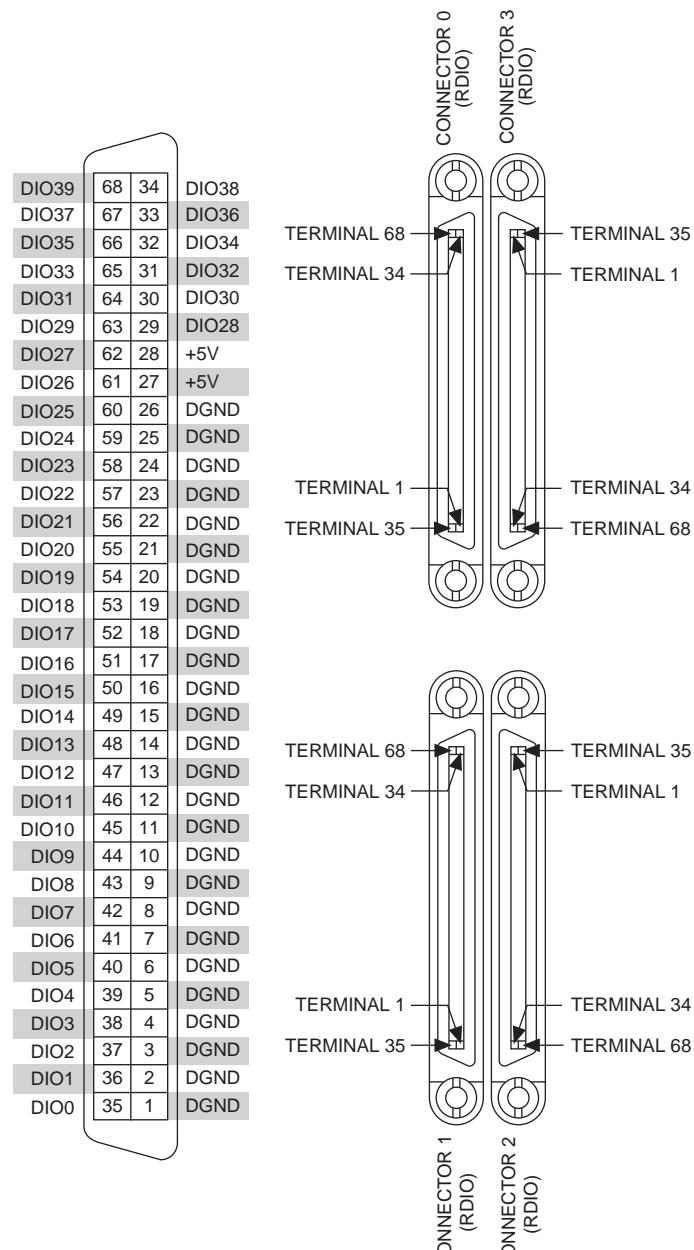


Figure 1. NI 781xR Connector Pin Assignments and Locations

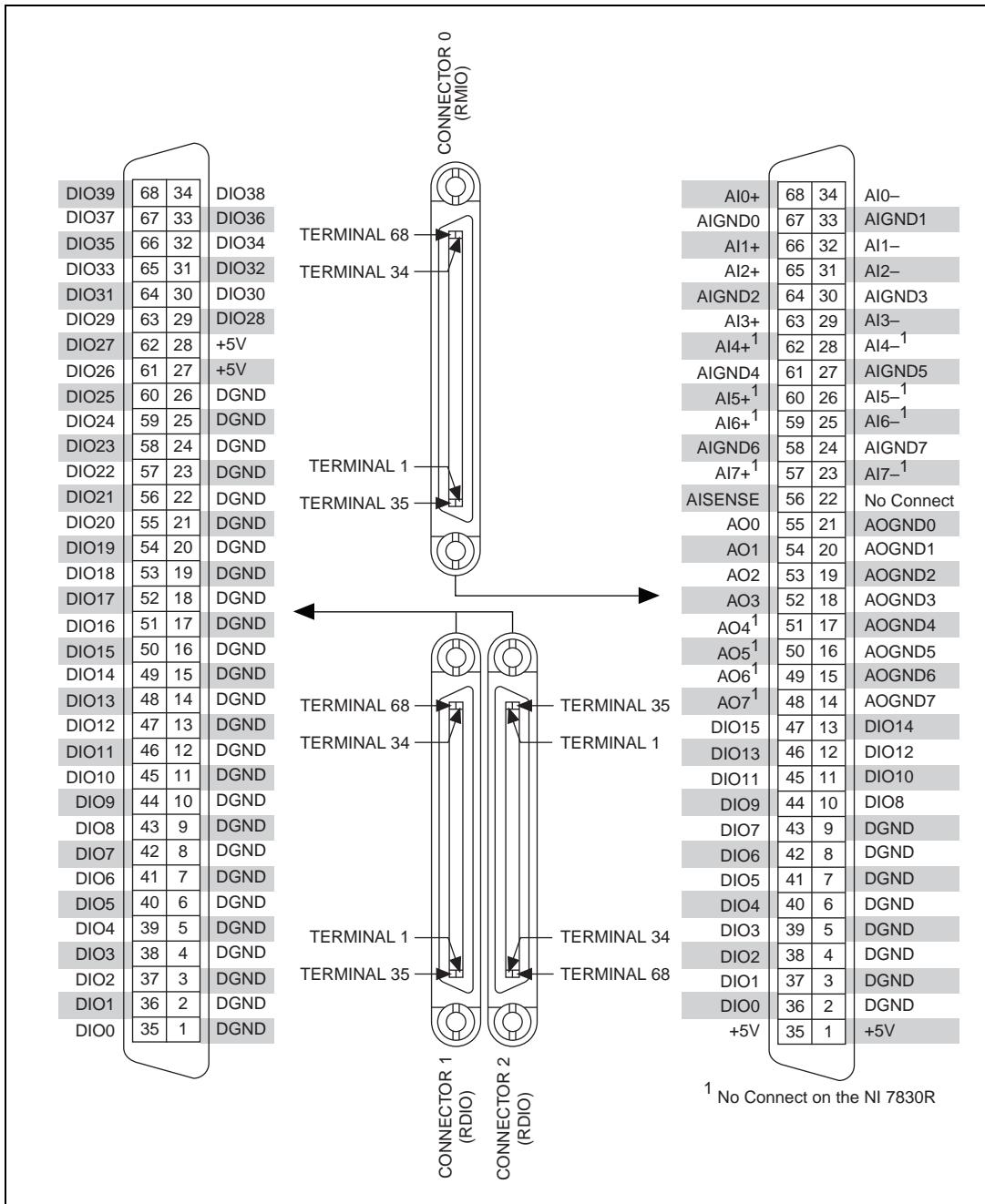


Figure 2. NI 783xR/784xR/785xR Connector Pin Assignments and Locations

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